## SM802128



ClockWorks<sup>™</sup> 10GbE Octal 156.25MHz, 312.5MHz, Ultra-Low Jitter, LVPECL Frequency Synthesizer

## **General Description**

The SM802128 is a member of the ClockWorks<sup>™</sup> family of devices from Micrel and provides an extremely low-noise timing solution for 10GbE Ethernet clock signals. It is based upon a unique patented RotaryWave<sup>®</sup> architecture that provides very low phase noise.

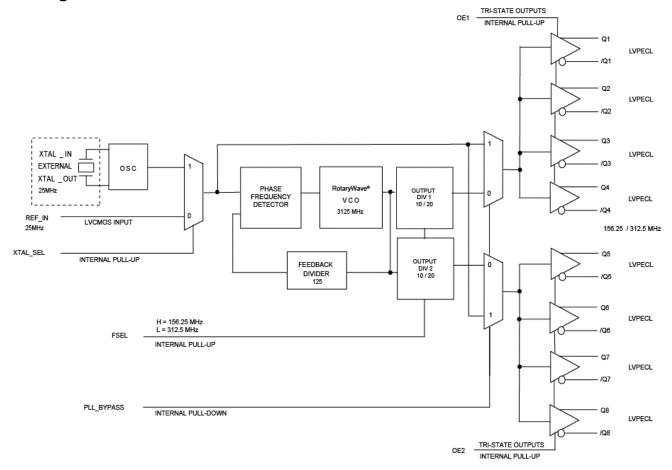
The device operates from a 3.3V or 2.5V power supply and synthesizes eight LVPECL output clocks at 156.25MHz or 312.5MHz. The SM802128 accepts a 25 MHz crystal or LVCMOS reference clock.

Data sheet and support documentation can be found on Micrel's web site at: www.micrel.com.

### **Features**

- Generates eight LVPECL clocks at 156.25MHz or 312.5MHz
- 2.5V or 3.3V operating range
- Typical phase jitter @ 156.25MHz
   (1.875MHz to 20MHz): 110fs with crystal reference
- Industrial temperature range (-40°C to +85°C)
- · Green, RoHS, and PFOS compliant
- Available in 44-pin 7mm × 7mm QFN package

## **Block Diagram**



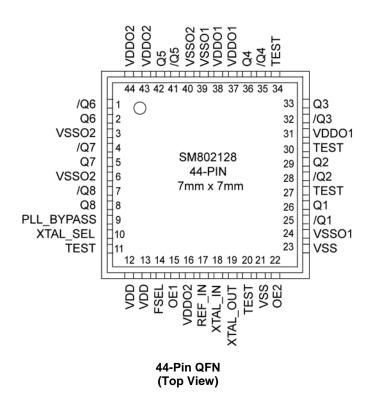
ClockWorks is a trademark of Micrel, Inc RotaryWave is a registered trademark of Multigig, Inc.

# Ordering Information (1)

Part Number	Marking	Shipping Temperature Range		Package
SM802128UMG	802128	Tray	–40°C to +85°C	44-Pin QFN
SM802128UMGTR	802128	Tape and Reel	–40°C to +85°C	44-Pin QFN

### Note:

## **Pin Configuration**



**Pin Description** 

Pin Number	Pin Name	Pin Type	Pin Level	Pin Function		
25, 26	/Q1, Q1					
28, 29	/Q2, Q2	O (DIE)	O, (DIF)  LVPECL  Differential Clock Outputs from Bank 1 (156.25MHz 312.5MHz).	Differential Clock Outputs from Bank 1 (156.25MHz or		
32, 33	/Q3, Q3	O, (DIF)		312.5MHz).	312.5MHz).	
35, 36	/Q4, Q4					
41, 42	/Q5, Q5					
1, 2	/Q6, Q6	O, (DIF)	LVPECL Differential Clock Outputs from Bank 2 (156.29 312.5MHz).	Differential Clock Outputs from Bank 2 (156.25MHz or		
4, 5	/Q7, Q7	O, (DIF)		312.5MHz).	312.5MHz).	312.5MHz).
7, 8	/Q8, Q8					
31, 37, 38	VDDO1	PWR		Power Supply for the Outputs on Bank 1.		
43, 44, 16	VDDO2	PWR		Power Supply for the Outputs on Bank 2.		
24, 39	VSSO1	PWR		Power Supply Ground for the Outputs on Bank 1.		

<sup>1.</sup> Devices are Green, RoHS, and PFOS compliant.

# Pin Description (continued)

Pin Number	Pin Name	Pin Type	Pin Level	Pin Function	
3, 6, 40	VSSO2	PWR		Power Supply Ground for the Outputs on Bank 2	
11, 20, 27, 30, 34	TEST			Factory Test Pins. Do not connect anything to these pins.	
12, 13	VDD	PWR		Core Power Supply	
21, 23	VSS (Exposed Pad)	PWR		Core Power Supply Ground. The exposed pad must be connected to the VSS ground plane.	
17	REF_IN	I, (SE)	LVCMOS	Reference Clock Input	
18	XTAL_IN	I, (SE)	Crystal	Crystal Reference Input, no load caps needed (See Figure 5).	
19	XTAL_OUT	O, (SE)	Crystal	Crystal Reference Output, no load caps needed (See Figure 5).	
15	OE1	I, (SE)	LVCMOS	Output Enable, Q1-Q4 disables to tri-state, 0 = Disabled, 1 = Enabled, 45KΩ Pull-Up.	
22	OE2	I, (SE)	LVCMOS	Output Enable, Q5-Q8 disables to tri-state, 0 = Disabled, 1 = Enabled, 45KΩ Pull-Up.	
				PLL Bypass, Selects Output Source	
9	PLL BYPASS	I, (SE)	LVCMOS	0 = Normal PLL Operation	
9	FLL_BTFA33	I, (SE)	LVCIVIOS	1 = Output from Input Reference Clock or Crystal	
				45KΩ Pull-Down	
10	XTAL SEL	I, (SE)	LVCMOS	Selects PLL Input Reference Source	
10	ATAL_SEL	1, (SE)	LVCIVIOS	0 = REF_IN, 1 = XTAL, 45KΩ Pull-Up	
14	FSEL	I, (SE)	LVCMOS	Frequency Select, 1 = 156.25MHz, 0 = 312.5MHz, 45K $\Omega$ Pull-Up	

# **Truth Tables**

OE1/2	
0	Tri-state
1	LVPECL

FSEL	Output Frequency (MHz)
0	312.5
1	156.25

PLL_BYPASS/CSB	XTAL_SEL		
0	_	_	PLL
1	_	_	XTAL/REF_IN
_	0	REF_IN	-
_	1	XTAL	_

# **Absolute Maximum Ratings** (1)

Supply Voltage (V <sub>DD</sub> , V <sub>DDO1/2</sub> )	+4.6V
Input Voltage (V <sub>IN</sub> )	0.50V to $V_{DD}$ +0.5V
Lead Temperature (soldering	, 20sec.)260°C
Case Temperature	115°C
Storage Temperature (T <sub>s</sub> )	65°C to +150°C

# Operating Ratings (2)

Supply Voltage (V <sub>DD</sub> , V <sub>DDO1/2</sub> )	+2.375V to +3.465V
Ambient Temperature (T <sub>A</sub> )	40°C to +85°C
Junction Thermal Resistance <sup>(3)</sup>	
QFN (θ <sub>JA</sub> )	
Still-Air	24°C/W
QFN (ψ JB)	
Junction-to-Board	8°C/W

## DC Electrical Characteristics (4)

 $V_{DD} = V_{DDO1/2} = 3.3V \pm 5\% \text{ or } 2.5V \pm 5\%$   $V_{DD} = 3.3V \pm 5\%, \ V_{DDO1/2} = 3.3V \pm 5\% \text{ or } 2.5V \pm 5\%$ 

 $T_A = -40^{\circ}C \text{ to } +85^{\circ}C.$ 

Symbol	Parameter	Condition	Min.	Тур.	Max.	Units
$V_{DD}, V_{DDO1/2}$	2.5V Operating Voltage	V <sub>DDO1</sub> =V <sub>DDO2</sub>	2.375	2.5	2.625	V
$V_{DD}, V_{DDO1/2}$	3.3V Operating Voltage	V <sub>DDO1</sub> =V <sub>DDO2</sub>	3.135	3.3	3.465	V
I <sub>DD</sub>	Supply current V <sub>DD</sub> + V <sub>DDO</sub>	156.25MHz		220	275	mΛ
	Outputs open	312.5MHz		275	345	mA

# LVPECL DC Electrical Characteristics (4)

 $V_{DD} = V_{DDO1/2} = 3.3V \pm 5\%$  or  $2.5V \pm 5\%$ 

 $V_{DD}$  = 3.3V  $\pm 5\%,\,V_{DDO1/2}$  = 3.3V  $\pm 5\%$  or 2.5V  $\pm 5\%$ 

 $T_A$  = -40°C to +85°C.  $R_L$  =  $50\Omega$  to  $V_{DDO}$ -2V

Symbol	Parameter	Condition	Min.	Тур.	Max.	Units
V <sub>OH</sub>	Output High Voltage		V <sub>DDO</sub> – 1.145	V <sub>DDO</sub> – 0.97	$V_{DDO} - 0.845$	V
V <sub>OL</sub>	Output Low Voltage		V <sub>DDO</sub> – 1.945	V <sub>DDO</sub> – 1.77	V <sub>DDO</sub> – 1.645	V
V <sub>SWING</sub>	Output Voltage Swing		0.6	0.8	1.0	V

# LVCMOS (PLL\_BYPASS, XTAL\_SEL, OE1, OE2, FSEL) DC Electrical Characteristics (4)

 $V_{DD}$  = 3.3V  $\pm 5\%,$  or 2.5V  $\pm 5\%,$   $T_{A}$  =  $-40^{\circ}C$  to  $+85^{\circ}C.$ 

Symbol	Parameter	Condition	Min.	Тур.	Max.	Units
V <sub>IH</sub>	Input High Voltage		2		V <sub>DD</sub> + 0.3	V
V <sub>IL</sub>	Input Low Voltage		-0.3		0.8	V
I <sub>IH</sub>	Input High Current	$V_{DD} = V_{IN} = 3.465V$			150	μΑ
I <sub>IL</sub>	Input Low Current	$V_{DD} = 3.465V, V_{IN} = 0V$	-150			μΑ

# **REF\_IN DC Electrical Characteristics**(4)

 $V_{DD}$  = 3.3V ±5%, or 2.5V ±5%,  $T_A$  = -40°C to +85°C.

Symbol	Parameter	Condition	Min.	Тур.	Max.	Units
V <sub>IH</sub>	Input High Voltage		1.1		V <sub>DD</sub> + 0.3	V
V <sub>IL</sub>	Input Low Voltage		-0.3		0.6	V
lisi	Input Current	$XTAL\_SEL = V_{IL}, V_{IN} = 0V \text{ to } V_{DD}$	-5		5	μА
IIN	I <sub>IN</sub> Input Current	XTAL_SEL = V <sub>IH</sub> , V <sub>IN</sub> = V <sub>DD</sub>		20		μΑ

# **Crystal Characteristics**

Parameter	Condition	Min.	Тур.	Max.	Units			
Mode of Oscillation	10pF Load	F	Fundamental, Parallel Resonant					
Frequency			25		MHz			
Equivalent Series Resistance (ESR)				50	Ω			
Shunt Capacitor, C0			1	5	pF			
Correlation Drive Level			10	100	uW			

# **AC Electrical Characteristics**(4, 5)

 $V_{DD} = V_{DDO1/2} = 3.3V \pm 5\%$  or  $2.5V \pm 5\%$ 

 $V_{DD}$  = 3.3V ±5%,  $V_{DDO1/2}$  = 3.3V ±5% or 2.5V ±5%

 $T_A = -40$ °C to +85°C.  $R_L = 50\Omega$  to  $V_{DDO} - 2V$ 

Symbol	Parameter	Condition	Min	Тур	Max	Units
F <sub>OUT1</sub>	Output Frequency 1	FSEL = 1		156.25		MHz
F <sub>OUT2</sub>	Output Frequency 2	FSEL = 0		312.5		MHz
F <sub>REF</sub>	Reference Input Frequency			25		MHz
T <sub>R</sub> /T <sub>F</sub>	LVPECL Output Rise/Fall Time	20% – 80%	80	175	350	ps
ODC	Output Duty Cycle		48	50	52	%
T <sub>SKEW</sub>	Output-to-Output Skew	Q1 – Q8 <sup>(6)</sup>			45	ps
T <sub>LOCK</sub>	PLL Lock Time				20	ms
T <sub>jit</sub> (∅)	RMS Phase Jitter <sup>(7)</sup>	156.25MHz Integration Range (1.875MHz – 20MHz) Integration Range (12kHz – 20MHz)  312.5MHz Integration Range (1.875MHz – 20MHz)		110 250		fs
	Spurious Noise Components	Integration Range (12kHz – 20MHz)  6.25MHz using 156.25MHz  12.5MHz using 312.5MHz		-80 -85		dBc

### Notes:

- Permanent device damage may occur if absolute maximum ratings are exceeded. This is a stress rating only and functional operation is not implied
  at conditions other than those detailed in the operational sections of this data sheet. Exposure to absolute maximum rating conditions for extended
  periods may affect device reliability.
- The data sheet limits are not guaranteed if the device is operated beyond the operating ratings.
- 3. Package thermal resistance assumes exposed pad is soldered (or equivalent) to the devices most negative potential on the PCB.
- 4. The circuit is designed to meet the AC and DC specifications shown in the above table after thermal equilibrium has been established.
- 5. All phase-noise measurements were taken with an Agilent 5052B phase-noise system.
- 6. Defined as skew between outputs at the same supply voltage and with equal load conditions and same frequency; measured at the output differential crossing points.
- 7. Measured using a 25MHz crystal as the input reference source. If using an external reference input, use a low phase noise source. With an external reference, the phase noise will follow the input source phase noise up to about 1MHz offset frequency.

# **Application Information**

### **Input Reference**

When operating with a crystal input reference, do not apply a switching signal to REF\_IN.

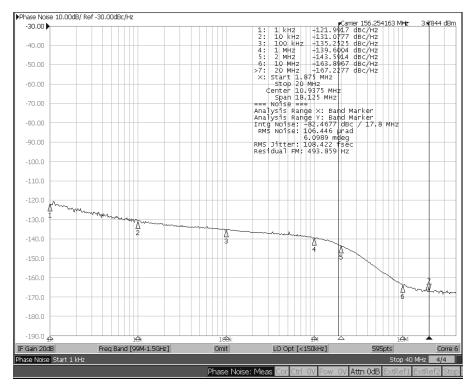
### **Crystal Layout**

Keep the layers under the crystal as open as possible and do not place switching signals or noisy supplies under the crystal.

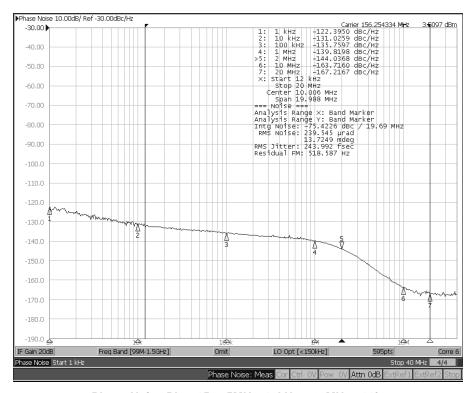
Crystal load capacitance is built inside the die so no external capacitance is needed. See the *Selecting a quartz crystal for the Clockworks Flex I Family of Precision Synthesizers* application note for further details.

Contact Micrel's HBW applications group if you need assistance on selecting a suitable crystal for your application at: <a href="https://hbwhelp@micrel.com">hbwhelp@micrel.com</a>.

### **Phase Noise Plots**

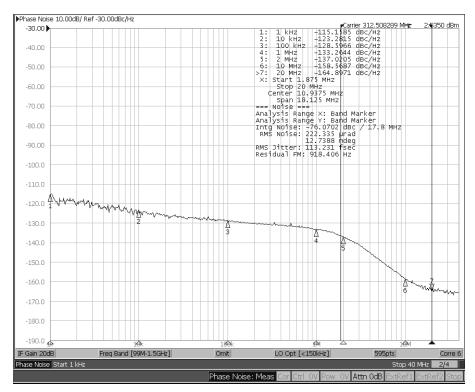


Phase Noise Plot: 156.25MHz, 1.875MHz - 20MHz 108fs

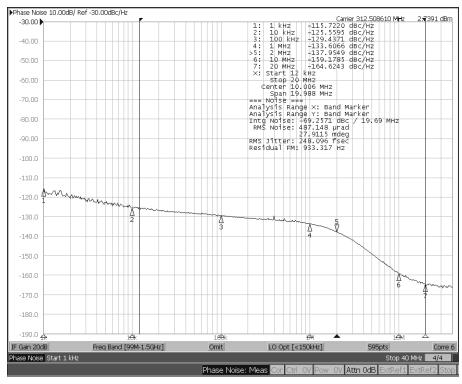


Phase Noise Plot: 156.25MHz, 12kHz - 20MHz 244fs

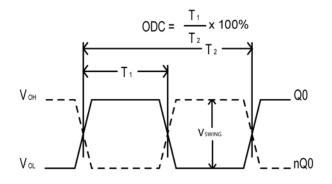
## **Phase Noise Plots (Continued)**



Phase Noise Plot: 312.5MHz, 1.875MHz - 20MHz 113fs



Phase Noise Plot: 312.5MHz, 12kHz - 20MHz 248fs



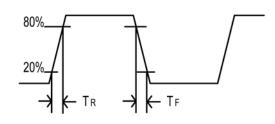


Figure 1. Duty Cycle Timing

Figure 2. All Outputs Rise/Fall Time

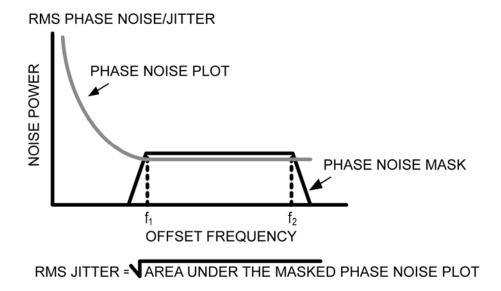
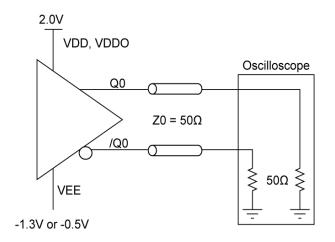


Figure 3. RMS Phase/Noise/Jitter



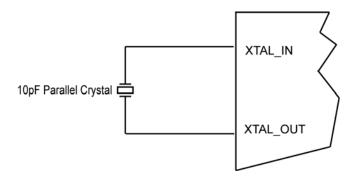
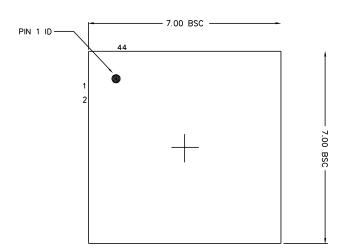


Figure 4. LVPECL Output Load

Figure 5. Crystal Input Interface

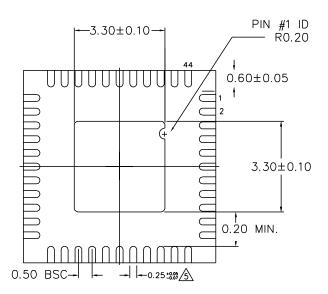
## **Package Information**



TOP VIEW



SIDE VIEW



BOTTOM VIEW

#### NOTE:

- ALL DIMENSIONS ARE IN MILLIMETERS.

  MAX. PACKAGE WARPAGE IS 0.05 mm.

  MAXIMUM ALLOWABE BURRS IS 0.076 mm IN ALL DIRECTIONS.

  PIN #1 ID ON TOP WILL BE LASER/INK MARKED.
- DIMENSION APPLIES TO METALIZED TERMINAL AND IS MEASURED BETWEEN 0.20 AND 0.25  $_{\mbox{\scriptsize mm}}$  FROM TERMINAL TIP.

APPLIED ONLY FOR TERMINALS.

APPLIED FOR EXPOSED PAD AND TERMINALS.

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